8-stage shift-and-store bus register Rev. 8 — 18 March 2021

1. General description

The 74LV4094 is an 8-bit serial-in/serial or parallel-out shift register with a storage register and 3-state outputs. Both the shift and storage register have separate clocks. The device features a serial input (D) and two serial outputs (QS1 and QS2) to enable cascading. Data is shifted on the LOW-to-HIGH transitions of the CP input. Data is available at QS1 on the LOW-to-HIGH transitions of the CP input to allow cascading when clock edges are fast. The same data is available at QS2 on the next HIGH-to-LOW transition of the CP input to allow cascading when clock edges are slow. The data in the shift register is transferred to the storage register when the STR input is HIGH. Data in the storage register appears at the outputs whenever the output enable input (OE) is HIGH. A LOW on OE causes the outputs to assume a high-impedance OFF-state. Operation of the OE input does not affect the state of the registers. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess V_{CC} .

2. Features and benefits

- Optimized for low voltage applications over a wide supply voltage range from 1.0 V to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical output ground bounce < 0.8 V at V_{CC} = 3.3 V and T_{amb} = 25 °C
- Typical HIGH-level output voltage (V_{OH}) undershoot: > 2 V at V_{CC} = 3.3 V and T_{amb} = 25 °C
- CMOS low power dissipation
- Direct interface with TTL levels
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
- ESD protection:
- HBM JESD22-A114E exceeds 2000 V
- MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Applications

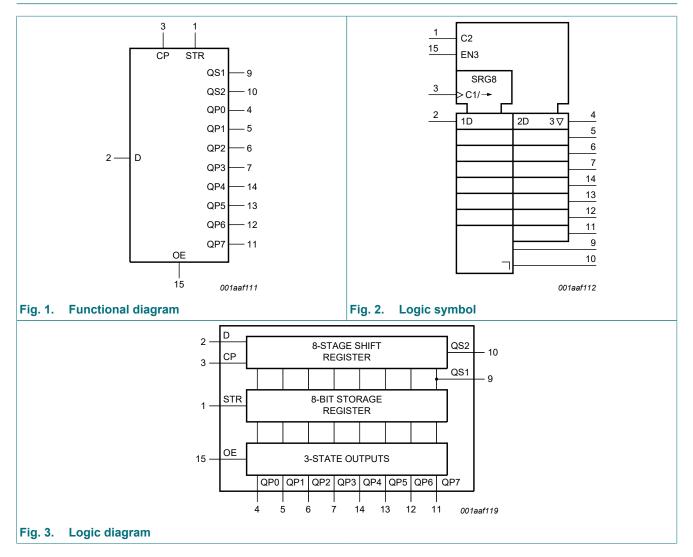
- Serial-to-parallel data conversion
- Remote control holding register



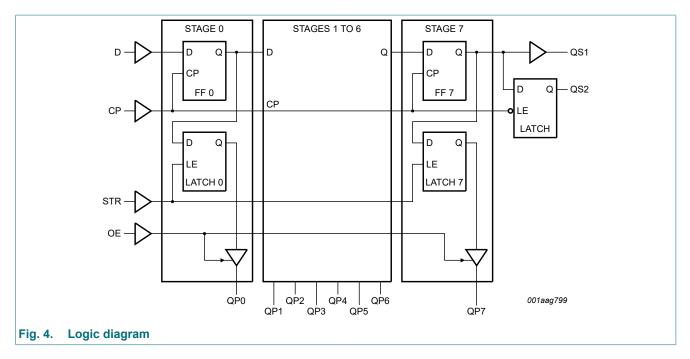
4. Ordering information

Type number	Package							
	Temperature range	Name	Description	Version				
74LV4094D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1				
74LV4094DB	-40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1				
74LV4094PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1				

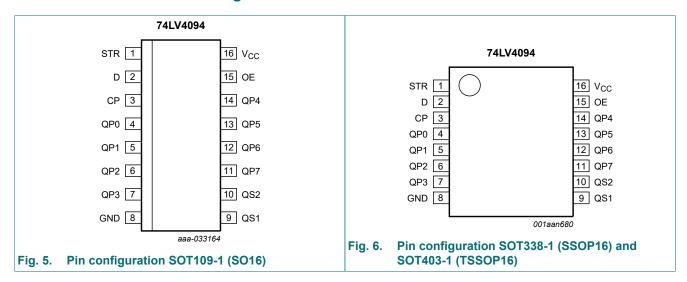
5. Functional diagram



8-stage shift-and-store bus register



6. Pinning information



6.1. Pinning

6.2. Pin description

Table 2. Pin description						
Symbol	Pin	Description				
STR	1	strobe input				
D	2	data input				
СР	3	clock input				
QP0 to QP7	4, 5, 6, 7, 14, 13, 12, 11	parallel output				
GND	8	ground supply voltage				
QS1, QS2	9,10	serial output				
OE	15	output enable input				
Vcc	16	supply voltage				

7. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = HIGH-impedance OFF-state; NC = no change;

 \uparrow = positive-going transition; \downarrow = negative-going transition;

Q6S = the data in register stage 6 before the LOW to HIGH clock transition;

Q7S = the data in register stage 7 before the HIGH to LOW clock transition.

Inputs			Parallel o	outputs	Serial out	Serial outputs	
СР	OE	STR	D	QP0	QPn	QS1	QS2
↑	L	X	Х	Z	Z	Q6S	NC
Ļ	L	Х	Х	Z	Z	NC	Q7S
↑	Н	L	Х	NC	NC	Q6S	NC
1	Н	Н	L	L	QPn -1	Q6S	NC
1	Н	Н	Н	н	QPn -1	Q6S	NC
Ļ	Н	Н	Н	NC	NC	NC	Q7S

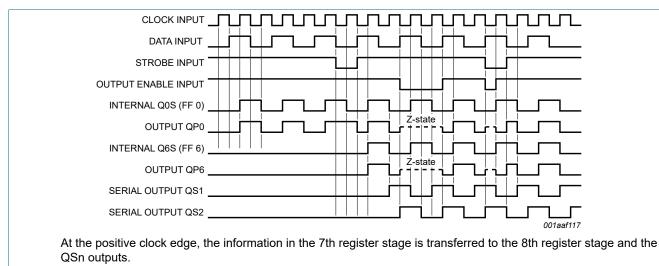


Fig. 7. Timing diagram

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
I _{ОК}	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	-	±50	mA
lo	output current	$V_{O} = -0.5 \text{ V to} (V_{CC} + 0.5 \text{ V})$	-	±25	mA
I _{CC}	supply current		-	+50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$ [1]	-	500	mW

For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.
 For SOT338-1 (SSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.
 For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage	[1]	1.0	3.3	3.6	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.0 V to 2.0 V	-	-	500	ns/V
		V _{CC} = 2.0 V to 2.7 V	-	-	200	ns/V
		V _{CC} = 2.7 V to 3.6 V	-	-	100	ns/V

[1] The static characteristics are guaranteed from V_{CC} = 1.2 V to V_{CC} = 5.5 V, but LV devices are guaranteed to function down to V_{CC} = 1.0 V (with input levels GND or V_{CC}).

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40) °C to 85	°C	-40 °C to	o +125 °C	Unit
			Min	Typ[1]	Max	Min	/lin Max	
V _{IH}	HIGH-level input	V _{CC} = 1.2 V	V _{CC}	0.6	-	V _{CC}	-	V
	voltage	V _{CC} = 2.0 V	1.4	-	-	1.4	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level input	V _{CC} = 1.2 V	-	0.4	GND	-	GND	V
	voltage	V _{CC} = 2.0 V	-	-	0.6	-	0.6	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level output	$V_{I} = V_{IH}$ or V_{IL} ; all pins						
voltage	I _O = -100 μA; V _{CC} = 1.2 V	-	1.2	-	-	-	V	
		I _O = -100 μA; V _{CC} = 2.0 V	1.8	2.0	-	1.8	-	V
		I _O = -100 μA; V _{CC} = 2.7 V	2.5	2.7	-	2.5	-	V
		I _O = -100 μA; V _{CC} = 3.0 V	2.8	3.0	-	2.8	-	V
		$V_{I} = V_{IH}$ or V_{IL} ; pins QPn						
		I _O = -6 mA; V _{CC} = 3.0 V	2.40	2.82	-	2.20	-	V
V _{OL}	LOW-level output	$V_{I} = V_{IH}$ or V_{IL} ; all pins						
	voltage	I _O = 100 μA; V _{CC} = 1.2 V	-	0	-	-	-	V
		I _O = 100 μA; V _{CC} = 2.0 V	-	0	0.2	-	0.2	V
		I _O = 100 μA; V _{CC} = 2.7 V	-	0	0.2	-	0.2	V
		I _O = 100 μA; V _{CC} = 3.0 V	-	0	0.2	-	0.2	V
		$V_{I} = V_{IH}$ or V_{IL} ; pins QPn						
		I _O = 6 mA; V _{CC} = 3.0 V	-	0.25	0.40	-	0.50	V
I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 3.6$ V	-	-	±1.0	-	±1.0	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{O} = V_{CC} \text{ or } GND;$ $V_{CC} = 3.6 \text{ V}$	-	-	±5.0	-	±10.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6$ V	-	-	20.0	-	160	μA
ΔI _{CC}	additional supply current	per input; $V_I = V_{CC} - 0.6 V$; $V_{CC} = 2.7 V$ to 3.6 V	-	-	500.0	-	850	μA
CI	input capacitance		-	3.5	-	-	-	pF

[1] All typical values are measured at T_{amb} = 25 °C.

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Fig. 12.

Symbol	Parameter	Conditions		-40	°C to 85 °	°C	-40 °C t	o +125 °C	Unit
				Min	Typ[1]	Мах	Min	Max	
t _{pd}	propagation	CP to QS1; see Fig. 8	[2]						
	delay	V _{CC} = 1.2 V		-	90	-	-	-	ns
		V _{CC} = 2.0 V		-	31	58	-	70	ns
		V _{CC} = 2.7 V		-	23	43	-	51	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	-	17	34	-	41	ns
		V _{CC} = 3.3 V; C _L = 15 pF		-	14	-	-	-	ns
		CP to QS2; see Fig. 8	[2]						
		V _{CC} = 1.2 V		-	80	-	-	-	ns
		V _{CC} = 2.0 V		-	27	51	-	61	ns
		V _{CC} = 2.7 V		-	20	38	-	45	ns
		V _{CC} = 3.0 V to 3.6 V		-	14	30	-	36	ns
		V _{CC} = 3.3 V; C _L = 15 pF	[3]	-	13	-	-	-	ns
		CP to QPn; see Fig. 8	[2]						
	V _{CC} = 1.2 V		-	115	-	-	-	ns	
		V _{CC} = 2.0 V		-	39	75	-	90	ns
		V _{CC} = 2.7 V		-	29	55	-	66	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	-	22	44	-	53	ns
		V _{CC} = 3.3 V; C _L = 15 pF		-	18	-	-	-	ns
		STR to QPn; see Fig. 9	[2]						
		V _{CC} = 1.2 V		-	105	-	-	-	ns
		V _{CC} = 2.0 V		-	36	68	-	82	ns
		V _{CC} = 2.7 V		-	26	50	-	60	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	-	20	40	-	48	ns
		V _{CC} = 3.3 V; C _L = 15 pF		-	17	-	-	-	ns
t _{en}	enable time	OE to QPn; see Fig. 10	[2]						
		V _{CC} = 1.2 V		-	100	-	-	-	ns
		V _{CC} = 2.0 V		-	34	65	-	77	ns
		V _{CC} = 2.7 V		-	25	48	-	56	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	-	19	38	-	45	ns
t _{dis}	disable time	OE to QPn; see <u>Fig. 10</u>	[2]						
		V _{CC} = 1.2 V		-	65	-	-	-	ns
		V _{CC} = 2.0 V		-	24	40	-	49	ns
		V _{CC} = 2.7 V		-	18	32	-	37	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	-	14	26	-	30	ns

8-stage shift-and-store bus register

Symbol	Parameter	Conditions		-40	°C to 85	°C	-40 °C t	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Мах	
t _W	pulse width	CP HIGH or LOW; see Fig. 8							
		V _{CC} = 2.0 V		34	9	-	41	-	ns
		V _{CC} = 2.7 V		25	6	-	30	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	20	5	-	24	-	ns
		STR HIGH; see Fig. 9							
		V _{CC} = 2.0 V		34	9	-	41	-	ns
		V _{CC} = 2.7 V		25	6	-	30	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	20	5	-	24	-	ns
t _{su} set-up time	set-up time	D to CP; see Fig. 11							
		V _{CC} = 1.2 V		-	25	-	-	-	ns
		V _{CC} = 2.0 V		22	9	-	26	-	ns
		V _{CC} = 2.7 V		16	6	-	19	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	13	5	-	15	-	ns
		CP to STR; see Fig. 9							
		V _{CC} = 1.2 V		-	50	-	-	-	ns
		V _{CC} = 2.0 V		43	17	-	51	-	ns
		V _{CC} = 2.7 V		31	13	-	38	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	25	10	-	30	-	ns
t _h	hold time	D to CP; see Fig. 11							
		V _{CC} = 1.2 V		-	-10	-	-	-	ns
		V _{CC} = 2.0 V		5	-4	-	+5	-	ns
		V _{CC} = 2.7 V		5	-3	-	+5	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	5	-2	-	+5	-	ns
		CP to STR; see Fig. 9							
		V _{CC} = 1.2 V		-	-25	-	-	-	ns
		V _{CC} = 2.0 V		5	-9	-	+5	-	ns
		V _{CC} = 2.7 V		5	-6	-	+5	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	5	-5	-	+5	-	ns
f _{max}	maximum	CP; see <u>Fig. 8</u>							
	frequency	V _{CC} = 2.0 V		14	52	-	12	-	MHz
		V _{CC} = 2.7 V		19	70	-	16	-	MHz
		V _{CC} = 3.0 V to 3.6 V	[3]	24	87	-	20	-	MHz
		V _{CC} = 3.3 V; C _L = 15 pF		-	95	-	-	-	MHz
C _{PD}	power dissipation capacitance	C_L = 50 pF; f = 1 MHz; V _I = GND to V _{CC}	[4]	-	83	-	-	-	pF

[1] All typical values are measured at T_{amb} = 25 °C.

[1] An typical values are measured at t_{amb} - 20 °C.
[2] t_{pd} is the same as t_{PLH} and t_{PHL}; t_{en} is the same as t_{PZH} and t_{PZL}; t_{dis} is the same as t_{PLZ} and t_{PHZ}.
[3] All typical values are measured at V_{CC} = 3.3 V.
[4] C_{PD} is used to determine the dynamic power dissipation (P_D in µW). P_D = C_{PD} x V_{CC}² x f_i x N + ∑(C_L x V_{CC}² x f_o) where:

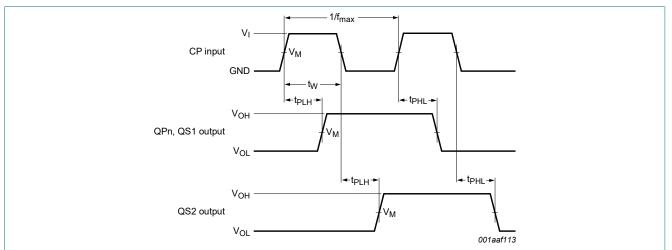
 f_i = input frequency in MHz; f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 Σ (C_L x V_{CC}² x f_o) = sum of outputs.

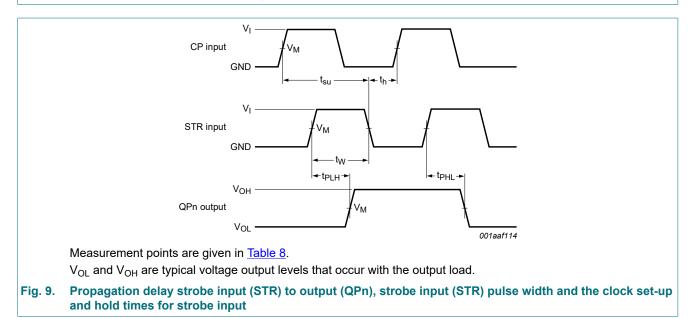


11.1. Waveforms and test circuit

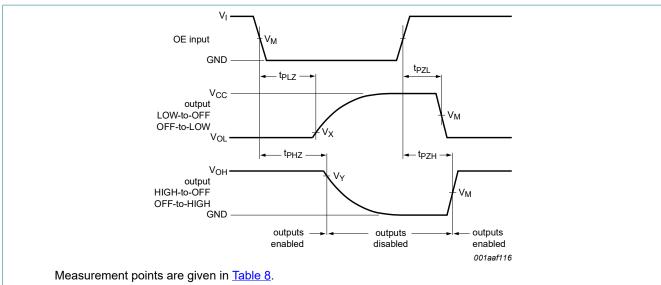
Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 8. Propagation delay input (CP) to output (QPn, QS1, QS2), output transition time, clock input (CP) pulse width and the maximum frequency (CP)

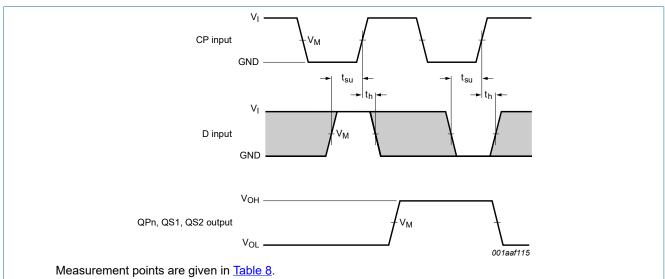


8-stage shift-and-store bus register



V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 10. Enable and disable times



 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 11.	The data input (D) t	o clock input (CP) set-	up times and clock input	t (CP) to data input (D) hold times
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Table 8. Measurement points

Supply voltage	Input	Output			
V _{cc}	V _M	V _M	V _X	V _Y	
< 2.7 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.1V _{CC}	V _{OH} - 0.1V _{CC}	
2.7 V to 3.6 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V	

8-stage shift-and-store bus register

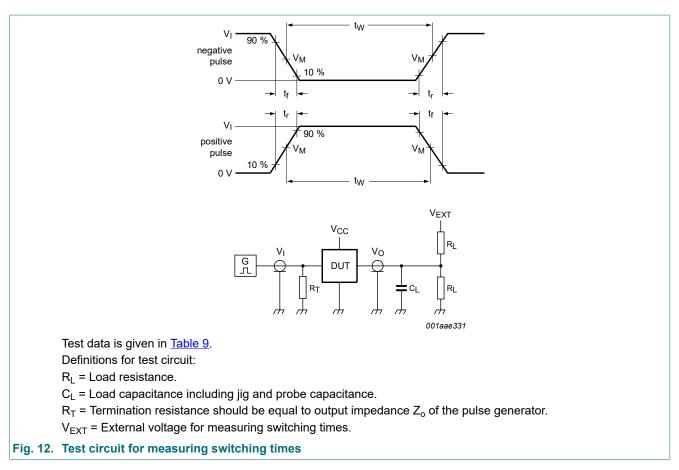


Table 9. Test data

Supply voltage	Input		Load		V _{EXT}		
V _{cc}	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
< 2.7 V	V _{CC}	≤ 2.5 ns	50 pF	1 kΩ	open	GND	2V _{CC}
2.7 V to 3.6 V	2.7 V	≤ 2.5 ns	15 pF, 50 pF	1 kΩ	open	GND	2V _{CC}

12. Package outline

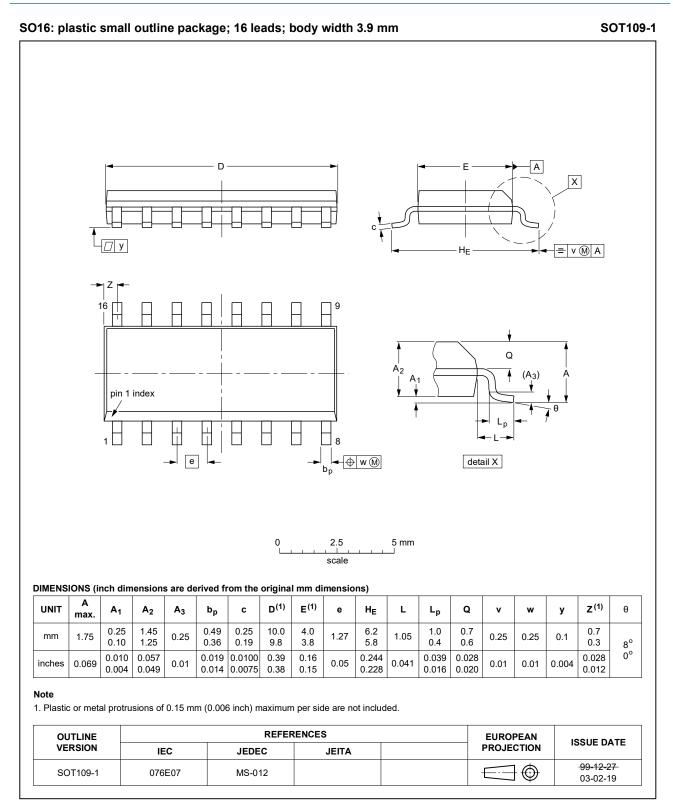


Fig. 13. Package outline SOT109-1 (SO16)

74LV4094

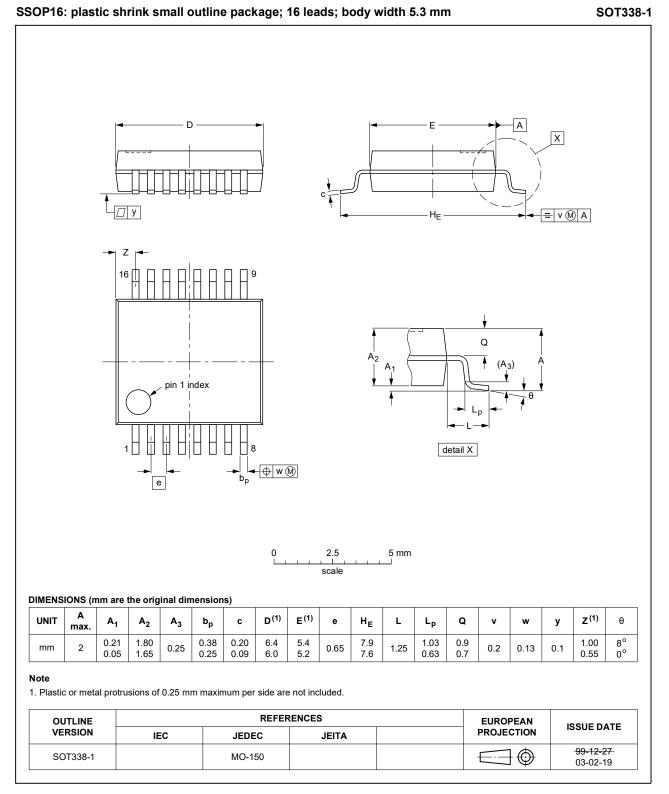


Fig. 14. Package outline SOT338-1 (SSOP16)

⁷⁴LV4094

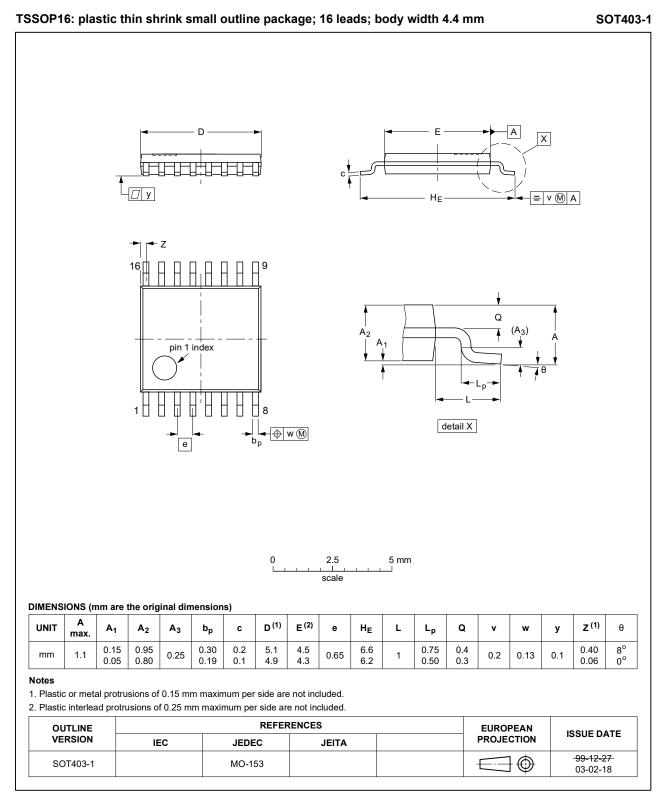


Fig. 15. Package outline SOT403-1 (TSSOP16)

⁷⁴LV4094

13. Abbreviations

Table 10. Abbreviati	Table 10. Abbreviations					
Acronym	Description					
CMOS	Complementary Metal Oxide Semiconductor					
DUT	Device Under Test					
ESD	ElectroStatic Discharge					
HBM	Human Body Model					
MM	Machine Model					
TTL	Transistor-Transistor Logic					

14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LV4094 v.8	20210318	Product data sheet	-	74LV4094 v.7	
Modifications:	Type number 74LV4094DB (SOT338-1 / SSOP16) added.				
74LV4094 v.7	20210205	Product data sheet	-	74LV4094 v.6	
Modifications:	 Type number 74LV4094DB (SOT338-1 / SSOP16) removed. <u>Section 1</u> and <u>Section 2</u> updated. <u>Section 8</u>: Derating values for P_{tot} total power dissipation updated. 				
74LV4094 v.6	20181114	Product data sheet	-	74LV4094 v.5	
Modifications:	guidelines	of this data sheet has been of Nexperia. have been adapted to the ected.	-		
74LV4094 v.5	20160318	Product data sheet	-	74LV4094 v.4	
Modifications:	Type number 74LV4094N (SOT38-4) removed.				
modifications.	Type name				
74LV4094 v.4	20111219	Product data sheet	-	74LV4094 v.3	
	20111219		-	74LV4094 v.3	
74LV4094 v.4	20111219	Product data sheet		74LV4094 v.3 74LV4094 v.2	
74LV4094 v.4 Modifications:	20111219 • Legal page	Product data sheet	- - -		

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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8-stage shift-and-store bus register

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Contents

1. General description	1
2. Features and benefits	1
3. Applications	1
4. Ordering information	2
5. Functional diagram	2
6. Pinning information	3
6.1. Pinning	3
6.2. Pin description	4
7. Functional description	4
8. Limiting values	5
9. Recommended operating conditions	5
10. Static characteristics	6
11. Dynamic characteristics	7
11.1. Waveforms and test circuit	9
12. Package outline	12
13. Abbreviations	15
14. Revision history	15
15. Legal information	
-	

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